

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention

Elimination of RDk Using Tape Base Flip Chip on Flex for Die
Stacking

Application Number : 10/050507
Confirmation Number: 7687
First Named Applicant: Teck Lee
Attorney Docket Number: MTI-31607
Art Unit: 2813
Examiner: Jack SJ Chen
Search string: (4415403 or 6847105).pn



US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	4415403	1983-11-15	Bakewell		216	27
	2	6847105	2005-01-25	Koopmans		257	686

Signature

Examiner Name	Date